



DIM. MIN. TYP. MAX.

* A	0.395 (10.03)	0.413 (10.49)	
* B	0.286 (7.26)	0.299 (7.59)	
C	0.088 (2.24)	0.105 (2.67)	
E	0.390 (9.90)	0.419 (10.64)	
F		0.350 (8.89)	
H	0.003 (0.08)	0.020 (0.51)	
J	0.013 (0.33)	0.020 (0.51)	
K		0.041 (1.04)	
K1		0.041 (1.04)	
L	0.016 (0.41)	0.050 (1.27)	
P		0.050 (1.27)	
T	0.009 (0.23)	0.0125 (0.32)	
W		45°	
X	0°		10°
Y		7°	

NOTE :

* A & B are reference datum's and do not include mold deflash or protrusions.

All dimensions in inches (mm.)

Angles are in degrees

Co-Planarity of leads within 0.004" (0.1mm)

TITLE		DRAWING No. D4 (DW)	
16-pin SOIC Package (Wide)		D'WN	S.D.F. © C.M.L. 2003
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